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	Substitute for form			Complete if Known			
				Application Number	10-723714		
INF	ORMATIO	N DISC	LOSURE	Filing Date	,		
	ATEMENT			First Named Inventor	Bing Ji, et al.		
	(Use as many s	heets as nec	essary)	Art Unit	1763		
				Examiner Name	George Goudresu		
Sheet	1	of	2	Attorney Docket Number	06299P2 USA		

			U. S. PATENT DO	CUMENTS		
Examiner Initials* ,	Cite No.1	Document Number	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or	
1. C. W. W.		Number-Kind Code <sup>2 (8 known)</sup>			Relevant Figures Appear	
1 1	-	US- 2001/0011526 AT	8/9/2001	K. Doering, et al.		
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		Country Code <sup>3</sup> Number <sup>4</sup> Kind Code <sup>5</sup> (I	_						
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7070	/	WO 00/40772	7/13/2000	World					
	1	WO 00/79019 A1	12/28/2000	World					
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	Substitute for for	n 1449/PTO		Complete if Known		
				Application Number	10-723714	
1	ORMATI ATEMEN			Filing Date		
31				First Named Inventor	Dingjun Wu, et al.	
	(Use as man	y sheets as nece	issary)	Art Unit	1763	
				Examiner Name	George Goudreau	
Sheet	2	of	2	Attorney Docket Number	06469 USA	

		NON PATENT LITERATURE DOCUMENTS				
Examiner Initials*	Cite No. 1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.				
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